TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

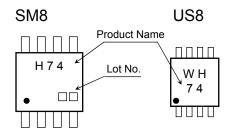
TC7WH74FU,TC7WH74FK

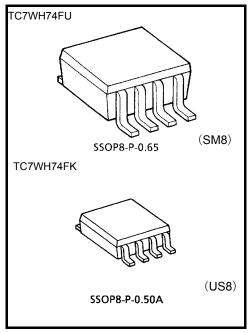
D-Type flip flop with preset and clear

Features

- High speed: f_{MAX} = 170 MHz (typ.) at V_{CC} = 5V
- Low power dissipation: I_{CC} = 2μA (max) at Ta = 25°C
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- 5.5-V tolerant inputs
- Balanced propagation delays: t_{pLH} ≃ t_{pHL}
- Wide operating voltage range: V_{CC} = 2 to 5.5V

Marking



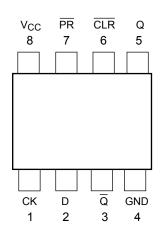


Weight SSOP8-P-0.65: 0.02 g (typ.) SSOP8-P-0.50A: 0.01 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	-0.5 to 7.0	V	
DC input voltage	V _{IN}	-0.5 to 7.0	٧	
DC output voltage	V _{OUT}	-0.5 to V_{CC} + 0.5	٧	
Input diode current	I _{IK}	-20	mA	
Output diode current	lok	±20 (Note 1)	mA	
DC output current	lout	±25	mA	
DC V _{CC} /ground current	Icc	±50	mA	
Dower dissination	PD	300 (SM8)	mW	
Power dissipation	FD	200 (US8)	11177	
Storage temperature	T _{stg}	-65 to 150	°C	
Lead temperature (10 s)	TL	260	°C	

Pin Assignment (top view)



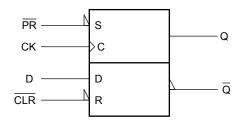
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$



IEC Logic Symbol



Truth Table

Inputs				Out	puts	Function	
CLR	PR	D	CK	Q	Q	Function	
L	Н	Х	Х	L	Н	Clear	
Н	L	Х	Х	Н	L	Preset	
L	L	X	X	Н	Η	l	
Н	Н	L	Ļ	L	Η		
Н	Н	Η	4	Н	L		
Н	Н	Х	ل ^ح ا	Qn	Qn	No Change	

X: Don't care

Operating Range

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 5.5	V
Input voltage	V _{IN}	0 to 5.5	V
Output voltage	V _{OUT}	0 to V _{CC}	٧
Operating temperature	T _{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 (V _{CC} = 3.3 \pm 0.3 V)	ns/V
input rise and rail time	uuuv	0 to 20 (V _{CC} = 5.0 ± 0.5 V)	110/V



Electrical Characteristics

DC Characteristics

Characteristics Symbol Test Co		ondition		٦	Га = 25°C)	Ta = -40 to 85°C		Unit	
Characteristics	Symbol	rest Condition		V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
			_		1.5	_	_	1.5	_	
High-level input voltage	V _{IH}				V _{CC} × 0.7	_	_	V _{CC} × 0.7	_	V
				2.0			0.5	_	0.5	
Low-level input voltage	V _{IL}		_		_	_	V _{CC} × 0.3	_	V _{CC} × 0.3	V
				2.0	1.9	2.0	_	1.9	_	V
		V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	3.0	2.9	3.0	_	2.9	_	
High-level output voltage	V _{OH}			4.5	4.4	4.5	_	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_	
			I _{OL} = 50 μA	2.0		0.0	0.1	_	0.1	V
				3.0		0.0	0.1	_	0.1	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}		4.5	_	0.0	0.1	_	0.1	
			I _{OL} = 4 mA	3.0			0.36	_	0.44	
			I _{OL} = 8 mA	4.5	_	_	0.36	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5			±0.1	_	±1.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5			2.0	_	20.0	μΑ

TIMING REQUIREMENTS (unless otherwise specified, Input: $t_{r} = t_{f} = 3 \ \text{ns}$)

Characteristics	Symbol	Symbol Test Condition		Ta = 25°C	Ta = -40 to 85°C	Unit
Gridiacteristics Syr		rest Condition	V _{CC} (V)	Limit	Limit	Offic
Minimum pulse width	t _W (L)		3.3 ± 0.3	6.0	7.0	
(CK)	t _W (H)		5.0 ± 0.5	5.0	5.0	
Minimum pulse width	t(1.)		3.3 ± 0.3	6.0	7.0	
(CLR , PR)	t _W (L)		5.0 ± 0.5	5.0	5.0	
Minimum setup time	+	+	3.3 ± 0.3	6.0	7.0	ns
	ts		5.0 ± 0.5	5.0	5.0	113
Minimum hold time t _h	+.	t _h	3.3 ± 0.3	0.5	0.5	
	чn		5.0 ± 0.5	0.5	0.5	
Minimum removal time			3.3 ± 0.3	5.0	5.0	
(CLR , PR)	(CLR, PR)		5.0 ± 0.5	3.0	3.0	

AC Characteristics (unless otherwise specified, Input: $t_r = t_f = 3$ ns)

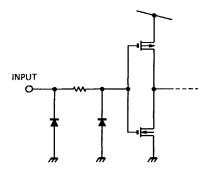
Characteristics	Symbol Test Condition				Ta = 25°C			Ta = -40~85°C		Unit
Characteristics	Symbol	rest Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Offic
			3.3 ± 0.3	15	_	6.7	11.9	1.0	14.0	
Propagation delay time	t _{pLH}		3.3 ± 0.3	50	_	9.2	15.4	1.0	17.5	ns
(CK-Q, \overline{Q})	t _{pHL}		5.0 ± 0.5	15		4.6	7.3	1.0	8.5	
			5.0 ± 0.5	50		6.1	9.3	1.0	10.5	
			33+03	15		7.6	12.3	1.0	14.5	- ns
Propagation delay time	t _{pLH}		3.3 ± 0.3	50		10.1	15.8	1.0	18.0	
$(\overline{CLR}, \overline{PR}-Q, \overline{Q})$	t _{pHL}		5.0 ± 0.5	15		4.8	7.7	1.0	9.0	
		5.0 ± 0.5	50		6.3	9.7	1.0	11.0		
			3.3 ± 0.3	15	80	125		70		
Maximum alaak fraguanay	f			50	50	75	_	45	_	MHz
Maximum clock frequency	f _{MAX}		50.05	15	130	170	_	110	_	IVITZ
		5.0 ± 0.5	50	90	115	_	75	_		
Input capacitance	C _{IN}					4	10	_	10	pF
Power dissipation capacitance	C _{PD}	(N	lote 2)		_	22	_	_		pF

Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

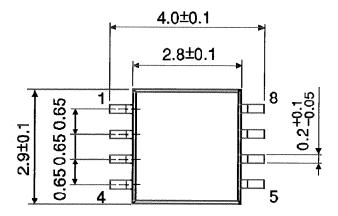
 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

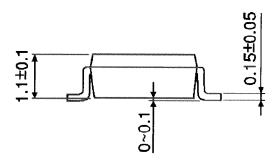
Input Equivalent Circuit



Package Dimensions

SSOP8-P-0.65 Unit: mm

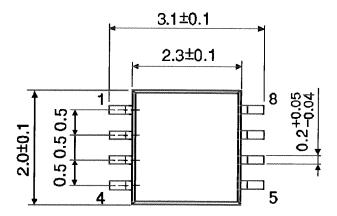


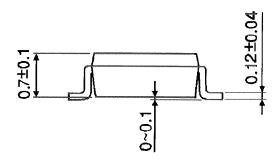


Mass: 0.02 g (typ.)

Package Dimensions

SSOP8-P-0.50A Unit: mm





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Mass: 0.01 g (typ.)

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